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APPLICATION NO.	FILING DATE	· FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	ATTORNEY DOCKET NO. CONFIRMATION NO	
09/764,242	01/19/2001	George Wong	CS98-070B	8930	
28112	7590 04/24/2003				
GEORGE (D. SAILE & ASSOCIA	EXAMINER			
28 DAVIS A POUGHKEI		1	DIAZ, JOSE R		
			ART UNIT	PAPER NUMBER	
	•		2815		
			DATE MAILED: 04/24/2003		

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application	No		- Op-
			140.	/pplicant(s)	(**
Office Action Summary		09/764,242		WONG, GEORGE	
	v	Examiner		Art Unit	
	The MAILING DATE of this communication a	José R Díaz		2815	
Period fo	The MAILING DATE of this communication a or Reply	ppears on the co	over sheet with the d	correspondence addr	ess
- Exte after If the If NC Failu	ORTENED STATUTORY PERIOD FOR REP MAILING DATE OF THIS COMMUNICATION no softime may be available under the provisions of 37 CFR 1 SIX (6) MONTHS from the mailing date of this communication, a period for reply specified above is less than thirty (30) days, a reprivation of the provision of the pr	I. 1.136(a). In no event, poly within the statutory d will apply and will ex- tte. Cause the applicat	however, may a reply be tin minimum of thirty (30) day pire SIX (6) MONTHS from	nely filed s will be considered timely. the mailing date of this comr	nunication.
1)[Responsive to communication(s) filed on 08	3 April 2003 .			•
2a) <u></u> □	This action is FINAL . 2b)⊠ T	This action is no	n-final.		
3)□ Dispositi	Since this application is in condition for allow closed in accordance with the practice unde on of Claims	wance except fo er <i>Ex parte Qua</i> y	r formal matters, pr de, 1935 C.D. 11, 4	osecution as to the r 53 O.G. 213.	merits is
4)[Claim(s) 18-22 is/are pending in the applicat	ion.			
	4a) Of the above claim(s) is/are withdra		leration		
	Claim(s) is/are allowed.		oration.		
	Claim(s) <u>18-22</u> is/are rejected.				
	Claim(s) is/are objected to.				
	Claim(s) are subject to restriction and/	or election requ	irement		
Application	on Papers		,,,,,,,,,,		
9)[] 7	he specification is objected to by the Examine	er.			
10)∐ T	he drawing(s) filed on is/are: a) ☐ acce	epted or b) obje	ected to by the Exan	niner.	
	Applicant may not request that any objection to the				
11) 🔲 T	he proposed drawing correction filed on				
	If approved, corrected drawings are required in re	eply to this Office			
12)[T	he oath or declaration is objected to by the Ex	xaminer.			
Priority u	nder 35 U.S.C. §§ 119 and 120				
13) 🔲 🛚	Acknowledgment is made of a claim for foreig	n priority under	35 U.S.C. § 119(a)	-(d) or (f).	
] All b) ☐ Some * c) ☐ None of:		- , ,	. , ,	
•	1. Certified copies of the priority documen	ts have been re	ceived.		
2	2. Certified copies of the priority document			n No	
	Copies of the certified copies of the prior application from the International Buse the attached detailed Office action for a list	ority documents ureau (PCT Rule	have been received 17.2(a)).	d in this National Sta	ge
	knowledgment is made of a claim for domest				nlication)
	☐ The translation of the foreign language pro				piication).
15)⊠ Á	cknowledgment is made of a claim for domest	tic priority under	35 U.S.C. §§ 120	and/or 121.	
ttachment(· •	33 : = 3 :		
) 🔲 Notice	of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PTO-948) ation Disclosure Statement(s) (PTO-1449) Paper No(s) _	4) [5) [6) [Interview Summary (Notice of Informal Pa Other:	PTO-413) Paper No(s) atent Application (PTO-15	2)
Patent and Trac O-326 (Rev.	A . A	ction Summary		Part of Pane	er No. 14

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DETAILED ACTION

Continued Examination Under 37 CFR 1.114

➤ A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on April 8, 2003 has been entered.

Claim Rejections - 35 USC § 102

> The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- Claims 18 and 19 are still rejected under 35 U.S.C. 102(e) as being anticipated by Saitou et al. (US Pat. No. 5,739,546). See Office action mailed on June 13, 2002.

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Claim Rejections - 35 USC § 103

> The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

- ➤ Claim 20 is still rejected under 35 U.S.C. 103(a) as being unpatentable over Saitou et al. (US Pat. No. 5,739,546) in view of Lou (US Pat. No. 5,759,906). See Office action mailed on June 13, 2002.
- Claims 21-22 are still rejected under 35 U.S.C. 103(a) as being unpatentable over Saitou et al. (US Pat. No. 5,739,546). See last Office action mailed on June 13, 2002.

Response to Arguments

Applicant's arguments filed April 8, 2003 have been fully considered but they are not persuasive. In summary, Applicant argues that Saitou et al. fails to teach a patterned fill layer, a planar silicon oxide layer, and a multilevel metal structure. However, the Examiner disagrees. With regards to the patterned fill layer, the reference Saitou et al. teaches a patterned conductive layer formed in the semiconductor region (2) and in the kerf areas (3) (see Figure 2). Please note, that the patterned conductive layer formed in the semiconductor region is identified by the reference sign (10), and the patterned conductive layer formed in the kerf areas is identified by the reference sign (6)

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(see Figure 1), both formed of the <u>same</u> metal material (please note that regions 6 and 10 are shown in Figure 2 having the same line pattern). In addition, the reference Saitou et al. teaches that the kerf area (3) are <u>filled</u> with the conductive layer (8) (see Figure 1) and the patterned conductive layer (6) (see Figure 2). Please note that Figure 1 does not show the patterned conductive layer (6) because the patterned conductive layer (6) is formed under the conductive layer (8) (see Figure 2). Thus, the patterned conductive layer (6) of Saitou et al. is a "patterned fill layer" since the patterned conductive layer (6) is formed in the kerf areas and is formed of the same metal material as the patterned conductive layer formed in the semiconductor region.

With regards to the planar silicon oxide layer, the Examiner disagrees with Applicant. Saitou et al. teaches a silicon oxide layer (7) formed on the patterned fill layer (6) (see Figure 2). After a carefully review of the drawings, the Examiner concluded that Figure 3, which is a cross sectional view of Figure 1, further provides the teaching of a planar layer, as required by Applicant. Figure 3 shows that, the silicon oxide layer (7) is planar over the surface of the patterned fill layer (6). Consequently, the reference Saitou et al. anticipates the claimed limitation since Saitou et al. teach a planar silicon oxide layer formed over the patterned fill layer.

Finally, with regards to the multilevel metal structure, the Examiner would like to point out that the reference Saitou et al. clearly anticipates such a limitation in column 6, lines 61-65, wherein Saitou et al. states that multilevel metal structure can also be formed as required. Therefore, Saitou et al. anticipates the claimed limitation of providing a multilevel metal structure.

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Correspondenc

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Any inquiry concerning this communication or earlier communications from the examiner should be directed to José R Díaz whose telephone number is (703) 308-

6078. The examiner can normally be reached on 9:00-5:00 Monday, Tuesday,

Thursday and Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Eddie Lee can be reached on (703) 308-1690. The fax phone numbers for

the organization where this application or proceeding is assigned are (703) 308-7722 for

regular communications and (703) 746-3891 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or

proceeding should be directed to the receptionist whose telephone number is (703) 308-

0956.

JRD

April 22, 2003

EDDIE LEE

SUPERVISORY PATENT EXAMINER

TECHNOLOGY CENTER 2800